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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







INTEGRATED CIRCUITS

DATA SHEET

74F153Dual 4-line to 1-line multiplexer

Product specification

1996 Jan 05

IC15 Data Handbook





74F153

FEATURES

- Non-inverting outputs
- Separate enable for each section
- Common select inputs
- See 74F253 for 3-State version

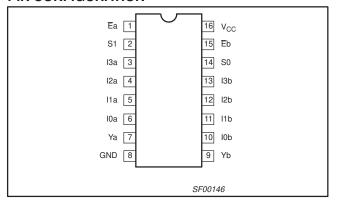
DESCRIPTION

The 74F153 is a dual 4-input multiplexer that can select 2 bits of data from up to four sources selected by common Select inputs (S0, S1). The two 4-input multiplexer circuits have individual active-Low Enables (Ea, Eb) which can be used to strobe the outputs independently. Outputs (Ya, Yb) are forced Low when the corresponding Enables (Ea, Eb) are High.

The 74F153 is the logic implementation of a 2-pole, 4-position switch where the switch is determined by the logic levels supplied to the common select inputs.

TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F153	7.0ns	12mA

PIN CONFIGURATION



ORDERING INFORMATION

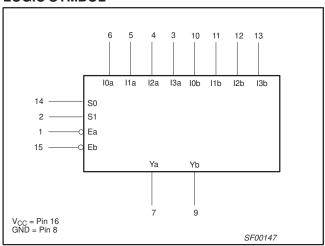
DESCRIPTION	COMMERCIAL RANGE V_{CC} = 5V $\pm 10\%$, T_{amb} = 0°C to +70°C	PKG. DWG.#
16-pin plastic DIP	N74F153N	SOT38-4
16-pin plastic SO	N74F153D	SOT109-1

INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

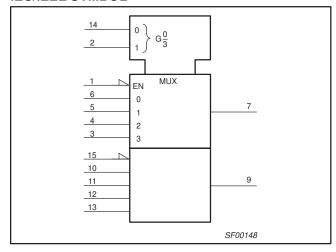
PINS	DESCRIPTION	74F (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
10a – 13a	Port A data inputs	1.0/1.0	20μA/0.6mA
10b – 13b	Port B data inputs	1.0/1.0	20μA/0.6mA
S0, S1	Common Select inputs	1.0/1.0	20μA/0.6mA
Ea	Port A Enable input (active Low)	1.0/1.0	20μA/0.6mA
Eb	Port B Enable input (active Low)	1.0/1.0	20μA/0.6mA
Ya, Yb	Port A, B data outputs	50/33	1.0μA/20mA

NOTE: One (1.0) FAST unit load is defined as: 20μA in the High state and 0.6mA in the Low state.

LOGIC SYMBOL



IEC/IEEE SYMBOL

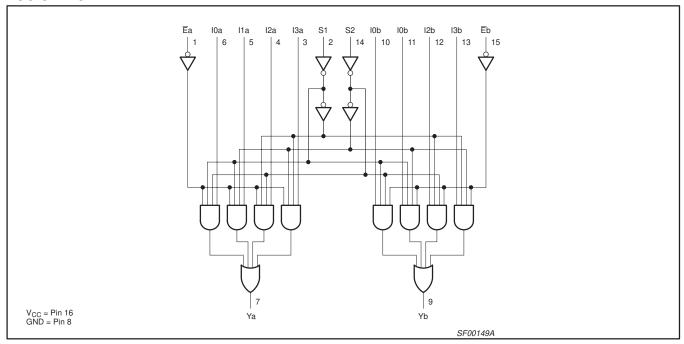


Philips Semiconductors Product specification

Dual 4-line to 1-line multiplexer

74F153

LOGIC DIAGRAM



FUNCTION TABLE

			INPUTS				OUTPUT	
S0	S1	En	l0n	l1n	l2n	l3n	Yn	
Х	Х	Н	Х	Х	Х	Х	L	
L	L	L	L	X	X	X	L	
L	L	L	Н	X	X	X	Н	
Н	L	L	X	L	X	X	L	
н	L	L	L	X	Н	X	X	Н
L	Н	L	X	X	L	X	L	
L	Н	L	X	X	Н	X	Н	
Н	Н	L	Х	X	X	L	L	
Н	Н	L	Х	Х	Х	Н	Н	

H = High voltage level L = Low voltage level X = Don't care

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ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limits set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V _{CC}	Supply voltage	-0.5 to +7.0	V
V _{IN}	Input voltage	−0.5 to +7.0	V
I _{IN}	Input current	−30 to +5	mA
V _{OUT}	Voltage applied to output in High output state	−0.5 to V _{CC}	V
I _{OUT}	Current applied to output in Low output state	40	mA
T _{amb}	Operating free-air temperature range	0 to +70	°C
T _{stg}	Storage temperature range	-65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

CVMPOL	PARAMETER		LIMITS		UNIT
SYMBOL	PARAMETER	MIN	NOM	MAX	UNIT
V _{CC}	Supply voltage	4.5	5.0	5.5	V
V _{IH}	High-level input voltage	2.0			V
V _{IL}	Low-level input voltage			0.8	V
I _{IK}	Input clamp current			-18	mA
I _{OH}	High-level output current			-1	mA
I _{OL}	Low-level output current			20	mA
T _{amb}	Operating free-air temperature range	0		+70	°C

DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

CVMDOL	DADAMETED		TEST COND	ITIONC1		UNIT		
SYMBOL	PARAMETER		TEST COND	IIION5.	MIN	TYP ²	MAX	UNII
V	Lligh level output valtage		V _{CC} = MIN, V _{IL} = MAX	±10%V _{CC}	2.5			V
V _{OH}	High-level output voltage		V _{IH} = MIN, I _{OH} = MAX	±5%V _{CC}	2.7	3.4		V
V	Low lovel output voltage		V _{CC} = MIN, V _{IL} = MAX	±10%V _{CC}		0.30	0.50	V
V _{OL}	Low-level output voltage		V _{IH} = MIN, I _{OL} = MAX		0.30	0.50	V	
V _{IK}	Input clamp voltage		$V_{CC} = MIN, I_I = I_{IK}$			-0.73	-1.2	V
I _I	Input current at maximum inpu	t voltage	$V_{CC} = MAX, V_I = 7.0V$			100	μΑ	
I _{IH}	High-level input current		$V_{CC} = MAX, V_I = 2.7V$			20	μΑ	
I _{IL}	Low-level input current		$V_{CC} = MAX, V_I = 0.5V$				-0.6	mA
Ios	Short-circuit output current ³		V _{CC} = MAX		-60		-150	mA
I _{CC}	Supply current (total)	I _{CCH}	V _{CC} = MAX	En = GND, Sn=In=4.5V		12	20	mA
	Supply current (total)			En=Sn=In=GND		12	20	mA

NOTES:

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^{1.} For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

All typical values are at V_{CC} = 5V, T_{amb} = 25°C.
 Not more than one output should be shorted at a time. For testing I_{OS}, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

Philips Semiconductors Product specification

Dual 4-line to 1-line multiplexer

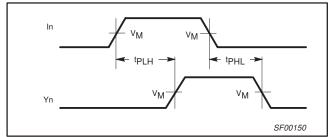
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AC ELECTRICAL CHARACTERISTICS

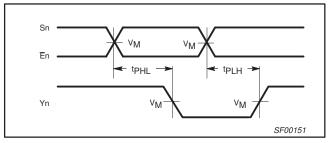
SYMBOL	PARAMETER	TEST CONDITION	T _{ai}	_{CC} = +5.0 _{mb} = +25 0pF, R _L =	°C	V _{CC} = +5. T _{amb} = 0°C C _L = 50pF,	UNIT	
			MIN	TYP	MAX	MIN	MAX	
t _{PLH} t _{PHL}	Propagation delay In to Yn	Waveform 1	3.0 3.0	4.5 5.0	7.0 7.5	2.5 2.5	8.0 8.0	ns
t _{PLH} t _{PHL}	Propagation delay Sn to Yn	Waveform 2	5.0 5.0	8.0 8.0	10.5 10.5	4.5 4.5	12.0 12.0	ns
t _{PLH} t _{PHL}	Propagation delay En to Yn	Waveform 2	5.0 4.0	7.5 5.5	9.0 7.0	4.5 3.5	10.5 8.0	ns

AC WAVEFORMS

For all waveforms, $V_M = 1.5V$.

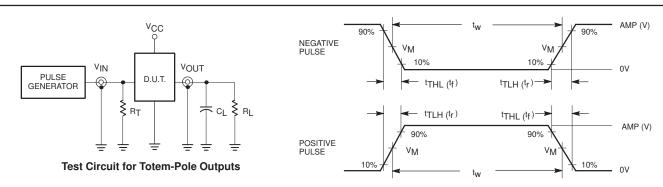


Waveform 1. Propagation Delay, Data to Output



Waveform 2. Propagation Delay, Enable and Select to Output

TEST CIRCUIT AND WAVEFORMS



DEFINITIONS:

R_L = Load resistor;

see AC ELECTRICAL CHARACTERISTICS for value.

C_L = Load capacitance includes jig and probe capacitance; see AC ELECTRICAL CHARACTERISTICS for value.

 $R_T = Termination resistance should be equal to <math display="inline">Z_{OUT}$ of pulse generators.

Input Pulse Definition

family	INP	UT PU	LSE REQU	REMEN	TS			
lallilly	amplitude	V_{M}	rep. rate	t _w	t _{TLH}	t _w t _{TLH} t _{TF}		
74F	3.0V	1.5V	1MHz	500ns	2.5ns	2.5ns		

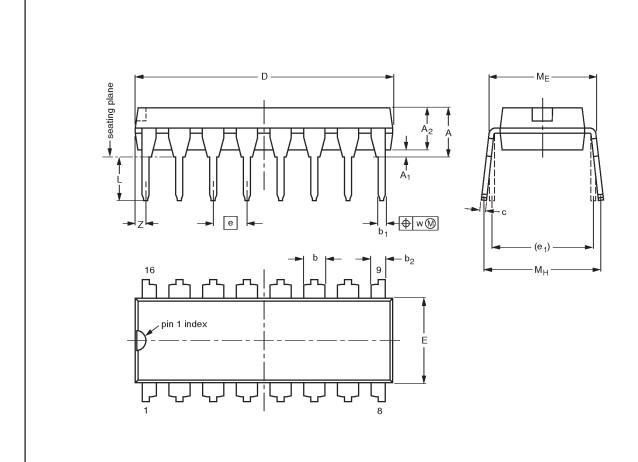
SF00006

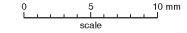
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DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4





DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	b ₂	С	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	ME	Мн	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

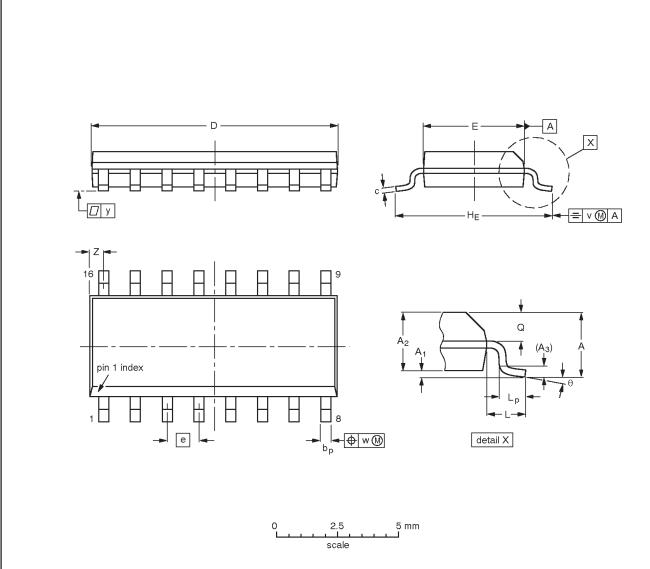
OUTLINE REFERENCES VERSION IEC JEDEC EIAJ	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT38-4				□ •	92-11-17 95-01-14

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SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.39 0.38	0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016		0.01	0.01	0.004	0.028 0.012	0°

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN	ISSUE DATE
	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT109-1	076E07S	MS-012AC				95-01-23 97-05-22

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Data sheet status

Data sheet status	Product status	Definition [1]	
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.	
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.	
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible productions.	

^[1] Please consult the most recently issued datasheet before initiating or completing a design.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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